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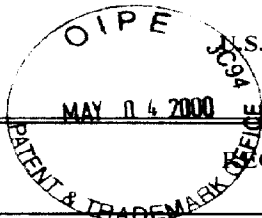
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APPENDIX B

DOCKET NO. 875_010CIP

Form PTO-1595

U.S. Department of Commerce

RECORDATION FORM COVER SHEET
PATENTS ONLY

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents on hand thereof.

1. Name of conveying party(ies)

Michihiko YANAGISAWA,
Chikai TANAKA, Shinya IIDA and
Yasuhiro HORIIKEAdditional name(s) of conveying parties attached ☒ No

2. Name and address of receiving party(ies):

Name: SpeedFam-IPEC Co., Ltd.
Address: Hayakawa 2647,
Ayase-shi, Kanagawa-ken,
Japan

and

3. Nature of Conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ OtherName: Yasuhiro Horiike
Address: 2-12, Higashifushimi 3-chome,
Houya-shi, Tokyo,
JapanExecution Date April 3, 2000Additional name(s) attached? ☒ No

4. Application number(s) or patent number(s)

If this document is being filed together with a new application, the execution date of this application is _____

A. Patent Application No.(s)

B. Patent No.(s)

09/514,676 filed February 28, 2000

Additional Numbers attached? ☒ No

5. Name and address of party to whom correspondence concerning this document should be mailed:

Name: Stephen P. Burr

Address: WALL MARJAMA BILINSKI & BURR
101 South Salina Street, Suite 400
Syracuse, NY 13202
Telephone: (315) 425-9000
Facsimile: (315) 425-91146. Total number of application and patents involved: 1

7. Total fee (37 CFR 3.4) \$40.00

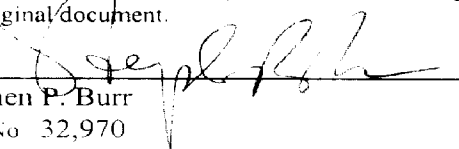
☒ Enclosed
☒ Authorized to charge any deficiency or credit any over payment to
Deposit Account No. 50-0289.

8. Charge Deposit account

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9. Statement and Signature:

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.


Stephen P. Burr
Reg. No. 32,970May 2, 2000

Date

Total Number of Pages Comprising Cover Sheet 3

OMB NO 0651-0011 (EXP. 4/94)

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PATENT

REEL: 010757 FRAME: 0237

ASSIGNMENT

(1-8) Insert Name(s) of Inventor(s)	(1) <u>Michihiko Yanagisawa</u>	(5) _____
	(2) <u>Chikai Tanaka</u>	(6) _____
	(3) <u>Shinya Iida</u>	(7) _____
	(4) <u>Yasuhiro Horiike</u>	(8) _____

In consideration of the sum of dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(9) Insert name of Assignee (9) SpeedFam-IPEC Co., Ltd. and Yasuhiro Horiike

(10) Insert address of Assignee (10) Hayakawa 2647, Ayase-shi, Kanagawa-ken, Japan and
2-12, Higashifushimi 3-chome, Houya-shi, Tokyo, Japan, respectively

(hereinafter designated as the Assignee) the entire right, title and interest for the United States, its territories, dependencies and possessions, in the invention, and all applications for patent and any Letters Patent which may be granted therefor, known as

(11) Insert Identification of Invention, such as Title, Case Number or Foreign Application Number (11) WAFER ETCHING METHOD
(Case No. 875_010CIP (SFP9815PUS))

for which the undersigned have executed an application for patent in the United States of America

(12) Insert Date of Signing of Application (12) on _____

(13) Alternative identification (13) U.S. Application(s) Serial Number(s) 09/514,676 for filed application(s) filed February 28, 2000

1) The undersigned agree(s) to execute all papers necessary in connection with the application and any continuing or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.

6) The undersigned hereby grant(s) Stephen P. Burr, of WALL MARJAMA BILINSKI & BURR the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date April 3, 2000 Signature Michihiko Yanagisawa (SEAL)
Michihiko Yanagisawa

Date March 21, 2000 Signature Chikai Tanaka (SEAL)
Chikai Tanaka

Date March 22, 2000 Signature Shinya Iida (SEAL)
Shinya Iida

Date April 1, 2000 Signature Yasuhiro Horiike (SEAL)
Yasuhiro Horiike

This assignment should preferably be signed before: (a) a Notary Public if within the U.S.A. or (b) a U.S. Consul if outside the U.S.A. If neither, then it should be signed before at least two witnesses who also sign here:

Date _____ Witness _____

Date _____ Witness _____